



## 100V P-Channel MOSFETs

### General Description

The TNM650 is the high cell density trench P-ch MOSFETs, which provides excellent  $R_{DS(ON)}$  and efficiency for most of the small power switching and load switch applications.

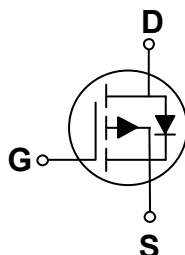
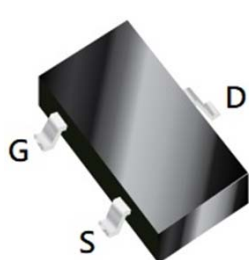
The TNM650 meets the RoHS and Green Product requirement with full function reliability approved.

$BV_{DSS}$	$R_{DS(ON)}$	$I_D$
-100V	650 m $\Omega$	-0.9 A

### Features

- $R_{DS(ON)} \leq 650m\Omega @ V_{GS} = -10V$
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available
- Advanced high cell density Trench technology

SOT-23 Pin Configuration



### Applications

- Battery Protection
- Load Switch
- Uninterruptible Power Supply

### Absolute Maximum Ratings $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	-100	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current - Continuous ( $T_A=25^\circ C$ )	-0.9	A
$I_{DM}$	Drain Current - Pulsed (NOTE 1)	-1.8	A
$P_D$	Total Power Dissipation ( $T_A=25^\circ C$ ) (NOTE 3)	1	W
$T_J$	Operating Junction Temperature Range	-50 to 150	$^\circ C$
$T_{STG}$	Storage Temperature Range	-50 to 150	$^\circ C$
Marking Code		AE , 0107	

### Thermal Characteristics

Symbol	Parameter	Typ.	Max	Unit
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	---	125	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	80	$^\circ C/W$



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Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V , I <sub>D</sub> = -250uA	-100	---	---	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> = -80V , V <sub>GS</sub> = 0V , T <sub>J</sub> =25°C	---	---	-10	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> = ±20V , V <sub>DS</sub> = 0V	---	---	±100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = -10V , I <sub>D</sub> = -0.8A	---	---	650	mΩ
		V <sub>GS</sub> = -4.5V , I <sub>D</sub> = -0.4A	---	---	700	
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> = -250uA	-1.0	---	-2.5	V
g <sub>fs</sub>	Forward Transconductance	V <sub>DS</sub> = -5V , I <sub>D</sub> = -0.8A	---	3	---	S

Dynamic and switching Characteristics

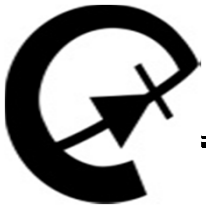
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = -15V , V <sub>GS</sub> = -4.5V , I <sub>D</sub> = -0.5A	---	4.5	---	nC
Q <sub>gs</sub>	Gate-Source Charge		---	1.14	---	
Q <sub>gd</sub>	Gate-Drain Charge		---	1.5	---	
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = -50V , V <sub>GS</sub> = -10V , R <sub>G</sub> = 3.3Ω , I <sub>D</sub> = -0.5A	---	13.6	---	ns
T <sub>r</sub>	Rise Time		---	6.8	---	
T <sub>d(off)</sub>	Turn-Off Delay Time		---	34	---	
T <sub>f</sub>	Fall Time		---	3	---	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = -15V , V <sub>GS</sub> = 0V , F= 1MHz	---	553	---	pF
C <sub>oss</sub>	Output Capacitance		---	29	---	
C <sub>rss</sub>	Reverse Transfer Capacitance		---	20	---	
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V , V <sub>DS</sub> =0V , F=1MHz	---	16	---	Ω

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I <sub>S</sub>	Continuous Source Current (NOTE 4)	V <sub>G</sub> = V <sub>D</sub> = 0V , Force Current	---	---	-0.9	A
I <sub>SM</sub>	Pulsed Source Current (NOTE 2 - 4)		---	---	-1.8	A
V <sub>SD</sub>	Diode Forward Voltage (NOTE 2)	V <sub>GS</sub> = 0V , I <sub>S</sub> = -1A , T <sub>J</sub> = 25°C	---	---	-1.2	V

NOTES :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
3. The power dissipation is limited by 150°C junction temperature.
4. The data is theoretically the same as I<sub>D</sub> and I<sub>DM</sub> , in real applications , should be limited by total power dissipation.



### Characteristics Curves

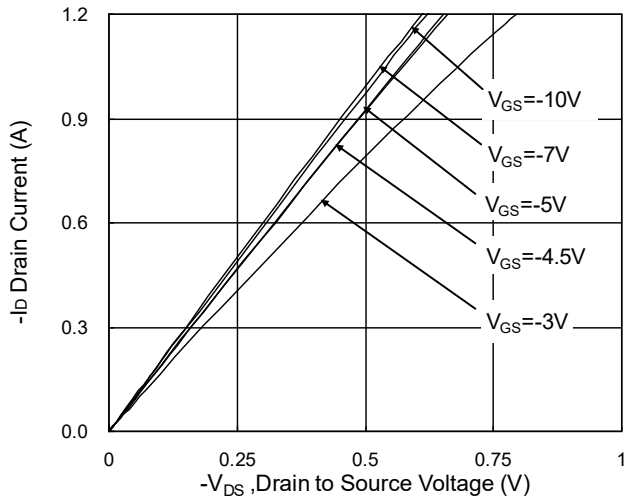


Fig.1 Typical Output Characteristics

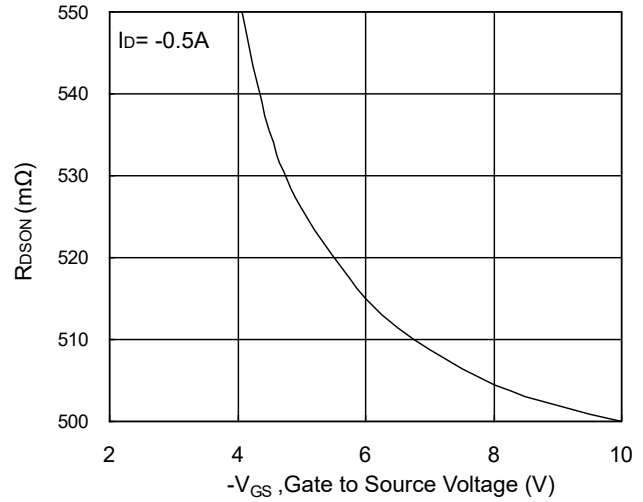


Fig.2 On-Resistance vs. Gate-Source Voltage

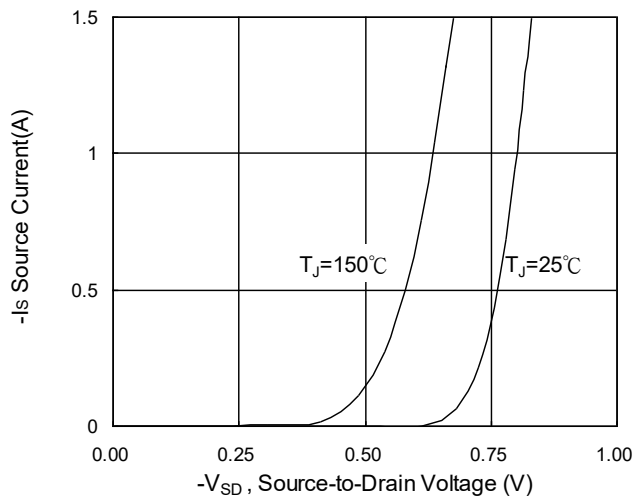


Fig.3 Forward Characteristics Of Diode

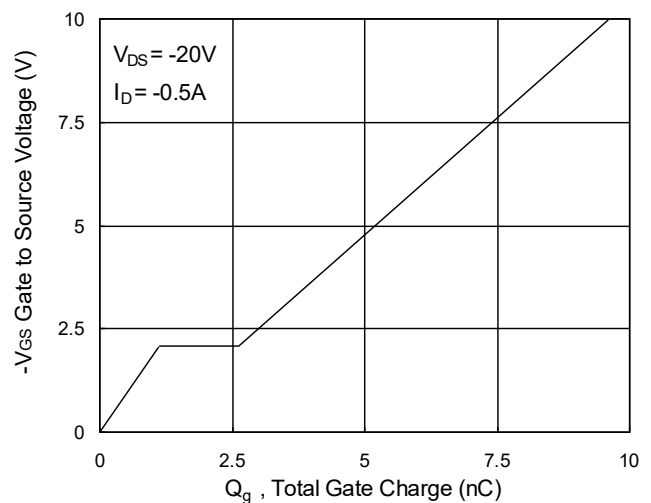


Fig.4 Gate-Charge Characteristics

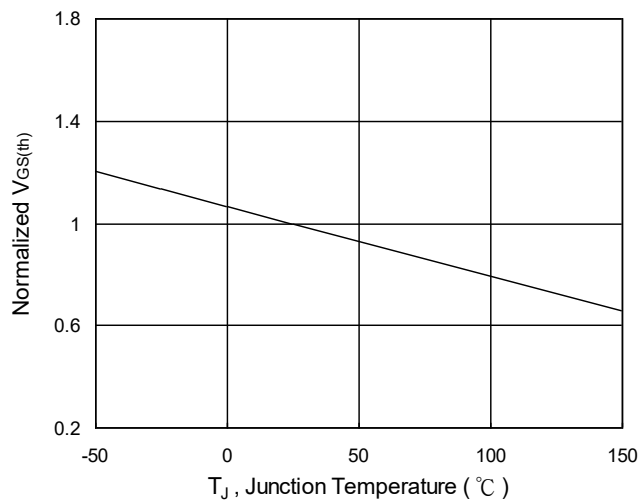


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$

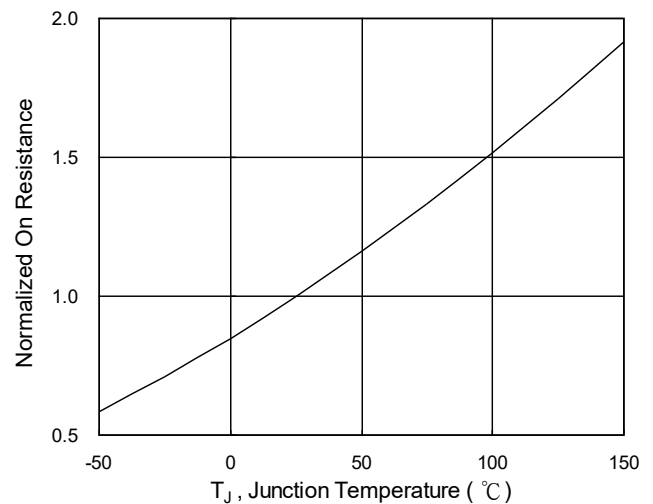
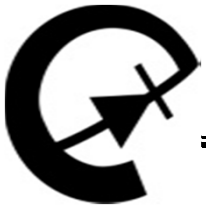


Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$



Characteristics Curves

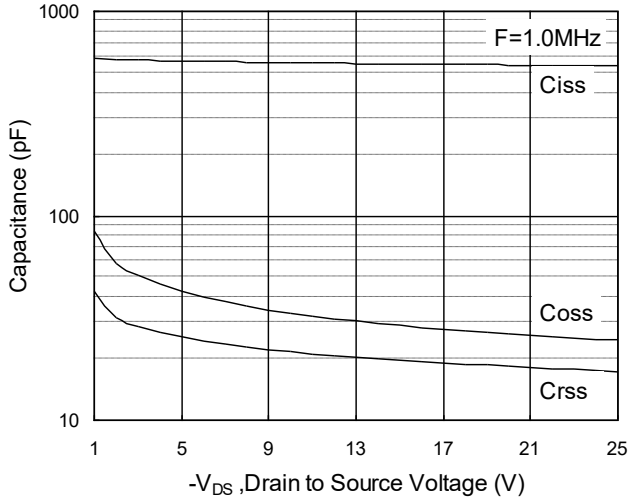


Fig.7 Capacitance

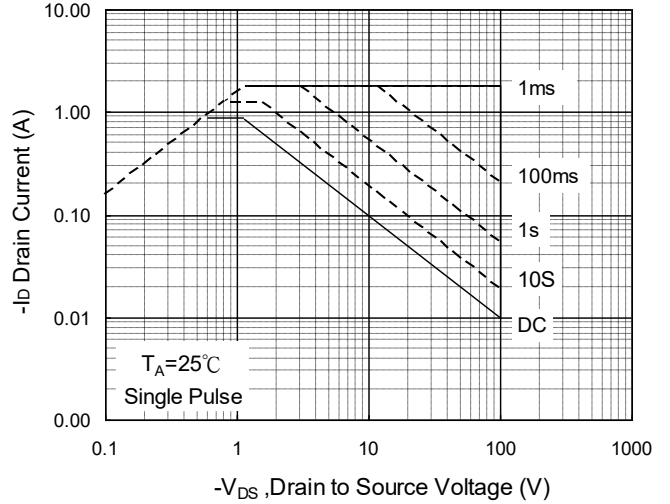


Fig.8 Safe Operating Area

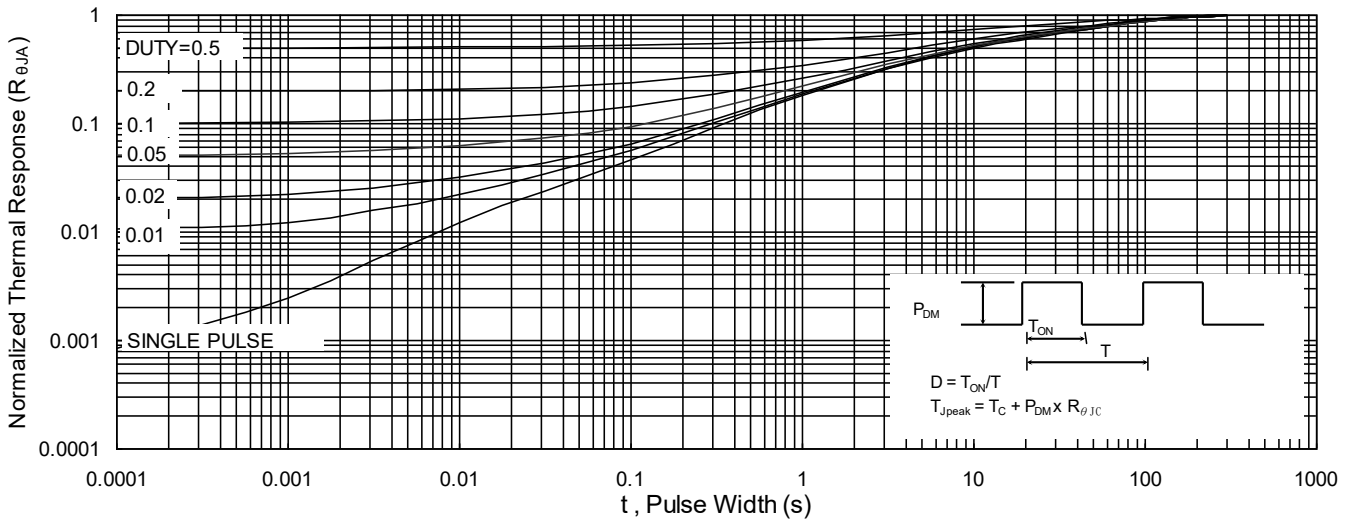


Fig.9 Normalized Maximum Transient Thermal Impedance

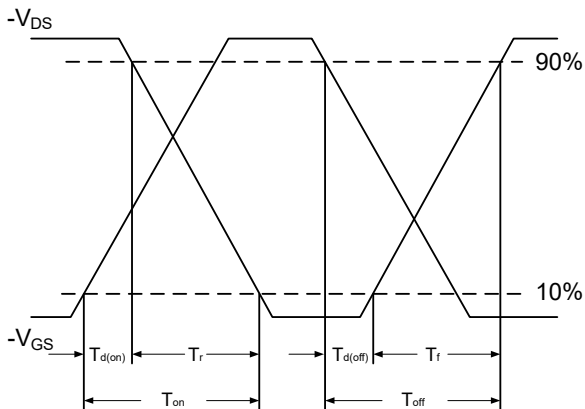


Fig.10 Switching Time Waveform

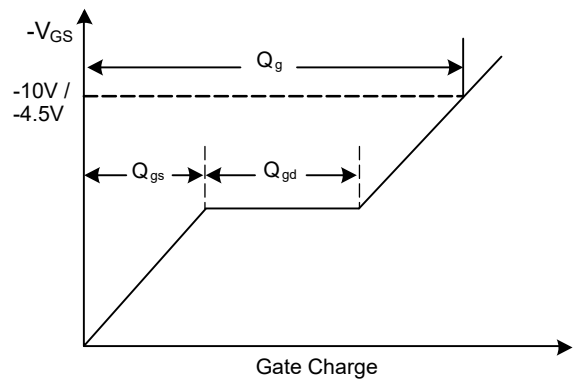
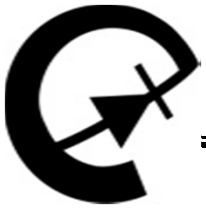
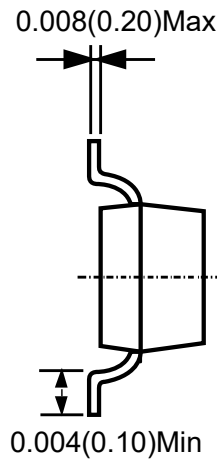
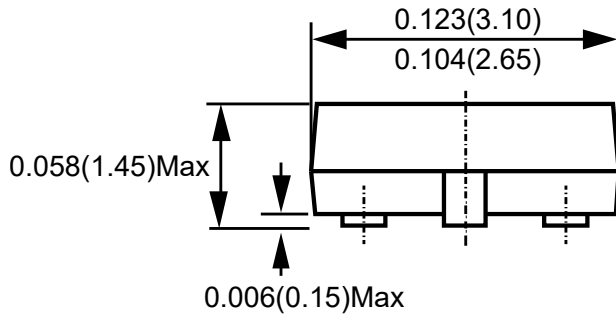
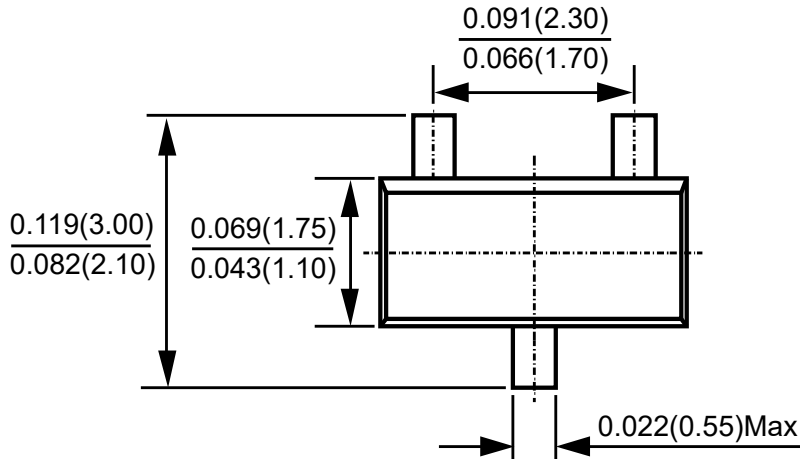


Fig.11 Gate Charge Waveform



Package Outline Dimensions



SOT-23

Dimensions in inches and (millimeters)



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